



Advanced Thermal Management Technologies: Experimental Case Studies, Numerical Modelling, and Topology Optimization

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Deadline for manuscript
submissions:

closed (30 April 2023)

Message from the Guest Editors

Dear Colleagues,

We are pleased to invite you to contribute to an upcoming Special Issue entitled: “*Advanced Thermal Management Technologies: Experimental case studies, numerical modelling, and topology optimization*”, which will be published in the journal *Designs*. This Special Issue is open to researchers and authors who want to submit their research and review articles exploring experimental and numerical analyses on thermal management applications, energy conversion, and cooling applications.

The main aim of this Special Issue is to investigate various thermal management system technologies to control the heat generated in several industrial applications. The focus will be on temperature uniformity, unsteady heat patterns, thermal circuit design, computational fluid dynamics, and topology optimization within hybrid and electric vehicles. This journal covers a wide range of topics including thermal management system design, energy conversion, energy storage, renewable energy, energy conservation, energy management, and sustainability.





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Message from the Editor-in-Chief

Designs (ISSN 2411-9660) is a peer-reviewed and open access journal which provides a unifying research framework for a wide range of engineering designs of disciplines and industrial applications, including mechanical engineering, electrical engineering, civil engineering, mechatronics, aerospace engineering, bioengineering, energy engineering, industrial engineering and manufacturing systems are of interest. We would like to invite you to contribute to the journal by sending us your high quality research papers. We would be pleased to welcome you as one of our authors.

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